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Global Computing Power Heat Dissipation Structural Components Market Research Report 2026(Status and Outlook)

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Abstracts

The 2025 U.S. tariff policies introduce profound uncertainty into the global economic landscape. This report critically examines the implications of recent tariff adjustments and international strategic countermeasures on Computing Power Heat Dissipation Structural Components competitive dynamics, regional economic interdependencies, and supply chain reconfigurations.In 2024, the price of computing power heat dissipation structural components was ??$4,049 per thousand units, with total sales reaching ?180 million units.Computing Power Heat Dissipation Structural Components?? are core metal structural parts that provide mechanical support and thermal conduction pathways for the cooling systems of high-performance computing devices (e.g., AI servers, GPU accelerators, data center switches). These components encompass precision die-cast/CNC-machined liquid cold plate substrates, high-thermal-conductivity fin array brackets, high-pressure-resistant sealed housings, and customized cooling frames for heterogeneous computing chips. They must meet stringent requirements for high heat flux density, multi-dimensional thermal topology, and long-term corrosion resistance. Their materials (e.g., copper alloys, aluminum silicon carbide) and manufacturing processes (e.g., ultra-thin channel milling, vacuum brazing) directly determine the cooling efficiency and reliability of computing equipment, serving as the critical physical interface between heat-generating units and active cooling components (e.g., liquid cooling pumps, immersion cooling systems).

The global Computing Power Heat Dissipation Structural Components market size was estimated at USD 729.0 million in 2025 and is projected to grow at a compound annual growth rate (CAGR) of 20.60% during the forecast period.

This report offers a comprehensive and in-depth analysis of the global Computing

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Power Heat Dissipation Structural Components market, covering all critical facets from a broad macroeconomic overview to detailed micro-level insights. It examines market size, competitive landscape, emerging development trends, niche segments, key drivers and challenges, as well as conducts SWOT and value chain analyses.

The insights provided enable readers to understand the competitive dynamics within the industry and formulate effective strategies to enhance profitability and market positioning. Additionally, the report presents a clear framework for evaluating the current status and future outlook of business organizations operating in this sector.

A significant focus of this report lies in the competitive landscape of the global Computing Power Heat Dissipation Structural Components market. It offers detailed profiles of major players, including their market shares, performance metrics, product portfolios, and operational status. This enables stakeholders to identify leading competitors and gain a nuanced understanding of market rivalry and structure.

In summary, this report serves as an essential resource for industry participants, investors, researchers, consultants, and business strategists, as well as anyone planning to enter or expand their presence in the Computing Power Heat Dissipation Structural Components market.

Global Computing Power Heat Dissipation Structural Components Market: Market Segmentation Analysis

This research report provides a detailed segmentation of the market by region (country), key manufacturers, product type, and application. Market segmentation divides the overall market into distinct subsets based on factors such as product categories, end-user industries, geographic locations, and other relevant criteria.

A clear understanding of these market segments enables decision-makers to tailor their product development, sales, and marketing strategies more effectively to meet the unique needs of each segment. Leveraging market segmentation insights can significantly enhance targeted approaches, optimize resource allocation, and accelerate product innovation cycles by aligning offerings with the specific demands of diverse customer groups.

Key Company

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Delta Electronics, Inc.
NIDEC CORPORATION
Dongguan Manko Hardware Products Co., Ltd.
Auras Technology Co., Ltd.
Jiangsu Gian Technology Co., Ltd.
Shenzhen FRD Technology Co., Ltd.
Casetek Precision Industrial Co., Ltd.
Beijing Zhongshi Weiye Technology Co., Ltd.
Guangdong Lingyi Intelligent Manufacturing Co., Ltd.
Taico Electronic (Zhuhai) Co., Ltd.
Forcecon Technology Co., Ltd.
Suzhou Tianmai Thermal Technology Co., Ltd.
QuanJing Technology Co., Ltd.
Shenzhen Winboth Thermal Technology Co., Ltd.

Market Segmentation (by Type)

Air-cooled
Liquid-cooled

Market Segmentation (by Application)

Server
Consumer Electronics
Telecommunication Equipment
Other

Geographic Segmentation

North America (USA, Canada, Mexico)

Europe (Germany, UK, France, Russia, Italy, Rest of Europe)

Asia-Pacific (China, Japan, South Korea, India, Southeast Asia, Rest of Asia-Pacific)

South America (Brazil, Argentina, Columbia, Rest of South America)

The Middle East and Africa (Saudi Arabia, UAE, Egypt, Nigeria, South Africa,

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Rest of MEA)

Key Benefits of This Market Research:

Industry drivers, restraints, and opportunities covered in the study
Neutral perspective on the market performance
Recent industry trends and developments
Competitive landscape & strategies of key players
Potential & niche segments and regions exhibiting promising growth covered
Historical, current, and projected market size, in terms of value
In-depth analysis of the Computing Power Heat Dissipation Structural Components Market
Overview of the regional outlook of the Computing Power Heat Dissipation Structural Components Market:

Customization of the Report

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Chapter Outline

Chapter 1 mainly introduces the statistical scope of the report, market division standards, and market research methods.

Chapter 2 is an executive summary of different market segments (by region, product type, application, etc), including the market size of each market segment, future development potential, and so on. It offers a high-level view of the current state of the Computing Power Heat Dissipation Structural Components Market and its likely evolution in the short to mid-term, and long term.

Chapter 3 makes a detailed analysis of the market's competitive landscape of the market and provides the market share, capacity, output, price, latest development plan, merger, and acquisition information of the main manufacturers in the market.

Chapter 4 is the analysis of the whole market industrial chain, including the upstream and downstream of the industry, as well as Porter's five forces analysis.

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Chapter 5 introduces the latest developments of the market, the driving factors and restrictive factors of the market, the challenges and risks faced by manufacturers in the industry, and the analysis of relevant policies in the industry.

Chapter 6 provides the analysis of various market segments according to product types, covering the market size and development potential of each market segment, to help readers find the blue ocean market in different market segments.

Chapter 7 provides the analysis of various market segments according to application, covering the market size and development potential of each market segment, to help readers find the blue ocean market in different downstream markets.

Chapter 8 provides a quantitative analysis of the market size and development potential of each region and its main countries and introduces the market development, future development prospects, market space, and capacity of each country in the world.

Chapter 9 shares the main producing countries of Computing Power Heat Dissipation Structural Components, their output value, profit level, regional supply, production capacity layout, etc. from the supply side.

Chapter 10 introduces the basic situation of the main companies in the market in detail, including product sales revenue, sales volume, price, gross profit margin, market share, product introduction, recent development, etc.

Chapter 11 provides a quantitative analysis of the market size and development potential of each region in the next five years.

Chapter 12 provides a quantitative analysis of the market size and development potential of each market segment in the next five years.

Chapter 13 is the main points and conclusions of the report.

Key Reasons to Buy this Report:

Access to date statistics compiled by our researchers. These provide you with historical and forecast data, which is analyzed to tell you why your market is set to change

This enables you to anticipate market changes to remain ahead of your

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competitors

You will be able to copy data from the Excel spreadsheet straight into your marketing plans, business presentations, or other strategic documents

The concise analysis, clear graph, and table format will enable you to pinpoint the information you require quickly

Provision of market value data for each segment and sub-segment

Indicates the region and segment that is expected to witness the fastest growth as well as to dominate the market

Analysis by geography highlighting the consumption of the product/service in the region as well as indicating the factors that are affecting the market within each region

Competitive landscape which incorporates the market ranking of the major players, along with new service/product launches, partnerships, business expansions, and acquisitions in the past five years of companies profiled

Extensive company profiles comprising of company overview, company insights, product benchmarking, and SWOT analysis for the major market players

The current as well as the future market outlook of the industry concerning recent developments which involve growth opportunities and drivers as well as challenges and restraints of both emerging as well as developed regions

Includes in-depth analysis of the market from various perspectives through Porter?s five forces analysis

Provides insight into the market through Value Chain

Market dynamics scenario, along with growth opportunities of the market in the years to come

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10 KEY COMPANIES PROFILE

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13 CONCLUSION AND KEY FINDINGS

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